

AN-1665 LM2735Y 5-Pin SOT23 Demo Board

1 Introduction

This demo board converts 3V to 5.5V input to 12V output for up to 500mA load current using the LM2735Y 520kHz DC-DC switching converter. This is a 2-layer board using the bottom layer as a ground plane.

A bill of materials describes the parts used on this demo board. A schematic and layout have also been included, along with measured performance characteristics. The above restrictions for the input voltage are valid only for the demo board as shipped with the demo board schematic shown in Figure 1.

2 Operating Conditions

- $V_{IN} = 3V \text{ to } 5.5V$
- V_O = 12V
- $I_0 = 500 \text{mA}$

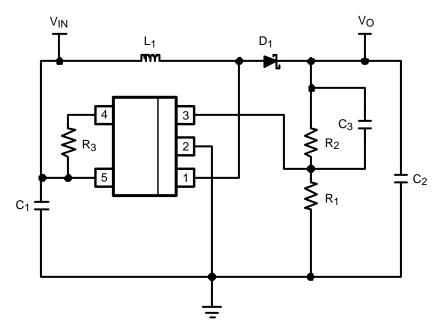


Figure 1. LM2735Y 5-Pin SOT Schematic



3 Pin Descriptions for 5-Pin SOT23

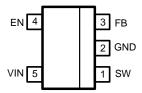


Figure 2. Pin-Out

Table 1. Pin Descriptions

Pin	Name	Function		
1	SW	Output switch. Connect to the inductor, output diode.		
2	GND	Signal and power ground pin. Place the bottom resistor of the feedback network as close as possible to this pin.		
3	FB	Feedback pin. Connect FB to external resistor divider to set output voltage.		
4	EN	Shutdown control input. Logic high enables operation. Do not allow this pin to float or be greater than VIN + 0.3V.		
5	VIN	Supply voltage for power stage, and Input supply voltage.		

4 Bill of Materials

Table 2. Bill of Materials

Part ID	Part Value	Manufacturer	Part Number
U1	2.1A Boost Regulator	Texas Instruments	LM2735
C1, Input Cap	22μF, 6.3V, X5R	TDK	C2012X5R0J226M
C2 Output Cap	10μF, 25V, X5R	TDK	C3216X5R1E106M
C3 Comp Cap	330pF	TDK	C1608X5R1H331K
D1, Catch Diode	0.4V _f Schottky 1A, 20V _R	ST	STPS120M
L1	22µH 2.3A	Coilcraft	DO3316P-223
R1	10.2kΩ, 1%	Vishay	CRCW06031022F
R2	86.6kΩ, 1%	Vishay	CRCW06038662F
R3	100kΩ, 1%	Vishay	CRCW06031003F



5 LM2735Y η vs Load Current, $V_o = 12V$

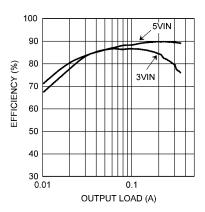


Figure 3. LM2735Y η vs Load Current, $V_0 = 12V$



PCB Layout www.ti.com

6 PCB Layout

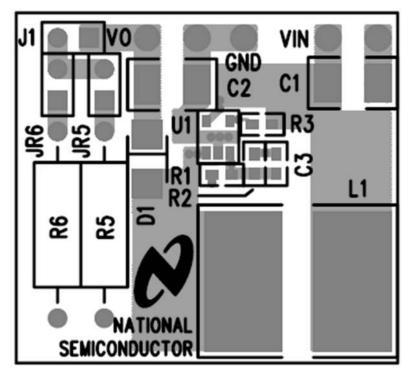


Figure 4. Top Layer

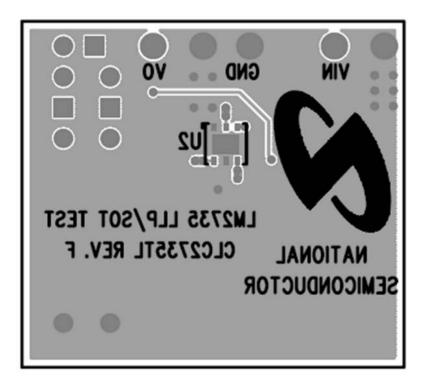


Figure 5. Bottom Layer

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive Communications and Telecom **Amplifiers** amplifier.ti.com www.ti.com/communications **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps

DSP **Energy and Lighting** dsp.ti.com www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical logic.ti.com Logic Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID www.ti-rfid.com

OMAP Applications Processors www.ti.com/omap TI E2E Community e2e.ti.com

Wireless Connectivity <u>www.ti.com/wirelessconnectivity</u>